Low-power inverter with open-drain output Rev. 1 — 15 January 2014

Product data sheet

#### **General description** 1.

The 74AXP1G06 is a single inverter with open-drain output.

Schmitt-trigger action at the input makes the circuit tolerant of slower input rise and fall times.

This device ensures very low static and dynamic power consumption across the entire V<sub>CC</sub> range from 0.7 V to 2.75 V. It is fully specified for partial power down applications using I<sub>OFF</sub>. The I<sub>OFF</sub> circuitry disables the output, preventing the potentially damaging backflow current through the device when it is powered down.

#### Features and benefits 2.

- Wide supply voltage range from 0.7 V to 2.75 V
- Low input capacitance; C<sub>1</sub> = 0.5 pF (typical)
- Low output capacitance; C<sub>O</sub> = 0.7 pF (typical)
- Low dynamic power consumption; C<sub>PD</sub> = 1.0 pF at V<sub>CC</sub> = 1.2 V (typical)
- Low static power consumption; I<sub>CC</sub> = 0.6 μA (85 °C maximum)
- High noise immunity
- Complies with JEDEC standard:
  - JESD8-12A.01 (1.1 V to 1.3 V)
  - JESD8-11A.01 (1.4 V to 1.6 V)
  - JESD8-7A (1.65 V to 1.95 V)
  - JESD8-5A.01 (2.3 V to 2.7 V)
- ESD protection:
  - HBM ANSI/ESDA/JEDEC JS-001 Class 2 exceeds 2 kV
  - CDM JESD22-C101E exceeds 1000 V
- Latch-up performance exceeds 100 mA per JESD 78 Class II
- Input accepts voltages up to 2.75 V
- Low noise overshoot and undershoot < 10 % of V<sub>CC</sub>
- I<sub>OFF</sub> circuitry provides partial Power-down mode operation
- Multiple package options
- Specified from –40 °C to +85 °C



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### 3. Ordering information

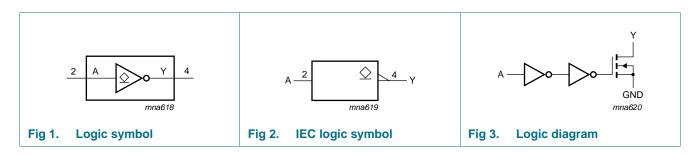
Type number	Package			
	Temperature range	Name	Description	Version
74AXP1G06GM	–40 °C to +85 °C	XSON6	plastic extremely thin small outline package; no leads; 6 terminals; body 1 $\times$ 1.45 $\times$ 0.5 mm	SOT886
74AXP1G06GN	–40 °C to +85 °C	XSON6	extremely thin small outline package; no leads; 6 terminals; body $0.9 \times 1.0 \times 0.35$ mm	SOT1115
74AXP1G06GS	–40 °C to +85 °C	XSON6	extremely thin small outline package; no leads; 6 terminals; body $1.0 \times 1.0 \times 0.35$ mm	SOT1202
74AXP1G06GX	–40 °C to +85 °C	X2SON5	X2SON5: plastic thermal enhanced extremely thin small outline package; no leads; 5 terminals; body $0.8 \times 0.8 \times 0.35$ mm	SOT1226

### 4. Marking

Table 2. Marking	
Type number	Marking code <sup>[1]</sup>
74AXP1G06GM	rR
74AXP1G06GN	rR
74AXP1G06GS	rR
74AXP1G06GX	rR

[1] The pin 1 indicator is located on the lower left corner of the device, below the marking code.

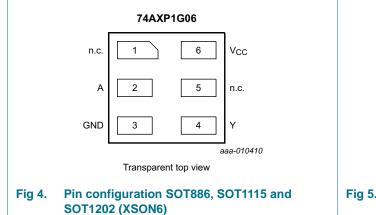
## 5. Functional diagram



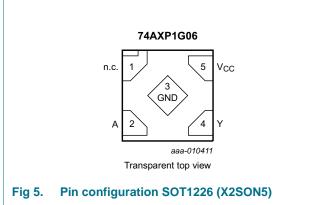
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## 6. Pinning information

### 6.1 Pinning



### 6.2 Pin description



Symbol	Pin		Description
	X2SON5	XSON6	
n.c.	1	1	not connected
A	2	2	data input
GND	3	3	ground (0 V)
Y	4	4	data output
n.c.	-	5	not connected
V <sub>CC</sub>	5	6	supply voltage

## 7. Functional description

### Table 4. Function table<sup>[1]</sup>

Input	Output
A	Y
L	Z
Н	L

[1] H = HIGH voltage level; L = LOW voltage level; Z = high-impedance OFF-state.

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### 8. Limiting values

#### Table 5. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134). Voltages are referenced to GND (ground = 0 V).

		<b>JJII</b> <i>J</i>	0	10	,
Symbol	Parameter	Conditions	Min	Max	Unit
V <sub>CC</sub>	supply voltage		-0.5	+3.3	V
I <sub>IK</sub>	input clamping current	V <sub>1</sub> < 0 V	-50	-	mA
VI	input voltage		<u>[1]</u> –0.5	+3.3	V
I <sub>OK</sub>	output clamping current	V <sub>O</sub> < 0 V	-50	-	mA
Vo	output voltage		<u>[1]</u> –0.5	+3.3	V
lo	output current	$V_{O} = 0 V$ to $V_{CC}$	-	±20	mA
I <sub>CC</sub>	supply current		-	50	mA
I <sub>GND</sub>	ground current		-50	-	mA
T <sub>stg</sub>	storage temperature		-65	+150	°C
P <sub>tot</sub>	total power dissipation	$T_{amb} = -40 \ ^{\circ}C$ to +85 $^{\circ}C$	-	250	mW

[1] The minimum input and output voltage ratings may be exceeded if the input and output current ratings are observed.

## 9. Recommended operating conditions

#### Table 6. Recommended operating conditions

Voltages are referenced to GND (ground = 0 V).

0	10				
Symbol	Parameter	Conditions	Min	Max	Unit
V <sub>CC</sub>	supply voltage		0.7	2.75	V
VI	input voltage		0	2.75	V
Vo	output voltage	Active mode	0	V <sub>CC</sub>	V
		Power-down mode; $V_{CC} = 0 V$	0	2.75	V
T <sub>amb</sub>	ambient temperature		-40	+85	°C
$\Delta t/\Delta V$	input transition rise and fall rate	$V_{CC}$ = 0.7 V to 2.75 V	0	200	ns/V

#### Low-power inverter with open-drain output

## **10. Static characteristics**

#### Table 7. Static characteristics

At recommended operating conditions, unless otherwise specified; voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions			T <sub>amb</sub> = -40 °	°C to +85 °C		Unit
				Min	Typ 25 °C	Max 25 °C	Max 85 °C	
VIH HIGH-level input		$V_{CC} = 0.75 \text{ V} \text{ to } 0.85 \text{ V}$		$0.75V_{CC}$	-	-	-	V
	voltage	$V_{CC} = 1.1 \text{ V}$ to 1.95 V		$0.65V_{CC}$	-	-	-	V
		$V_{CC}$ = 2.3 V to 2.7 V		1.6	-	-	-	V
V <sub>IL</sub>	LOW-level input	$V_{CC}$ = 0.75 V to 0.85 V		-	-	$0.25V_{CC}$	$0.25V_{CC}$	V
	voltage	$V_{CC} = 1.1 \text{ V}$ to 1.95 V		-	-	$0.35V_{CC}$	$0.35V_{CC}$	V
		$V_{CC}$ = 2.3 V to 2.7 V		-	-	0.7	0.7	V
V <sub>OL</sub>	LOW-level output	$I_O$ = 20 $\mu$ A; $V_{CC}$ = 0.7 V		-	0.01	-	-	V
	voltage	$I_{O}$ = 100 $\mu$ A; $V_{CC}$ = 0.75 V		-	-	0.1	0.1	V
		$I_{O} = 2 \text{ mA}; V_{CC} = 1.1 \text{ V}$		-	-	0.275	0.275	V
		$I_{O} = 3 \text{ mA}; V_{CC} = 1.4 \text{ V}$		-	-	0.35	0.35	V
		$I_{O}$ = 4.5 mA; $V_{CC}$ = 1.65 V		-	-	0.45	0.45	V
		$I_{O} = 8 \text{ mA}; V_{CC} = 2.3 \text{ V}$		-	-	0.7	0.7	V
lı	input leakage current	$V_{I} = 0 V \text{ to } 2.75 V;$ $V_{CC} = 0 V \text{ to } 2.75 V$	[1]	-	0.001	±0.1	±0.5	μA
I <sub>OZ</sub>	OFF-state output current	$V_I = V_{IL}$ ; $V_O = 0$ V to 2.75 V	[1]	-	0.02	±0.1	±0.5	μA
I <sub>OFF</sub>	power-off leakage current	$V_1 \text{ or } V_0 = 0 \text{ V to } 2.75 \text{ V};$ $V_{CC} = 0 \text{ V}$	<u>[1]</u>	-	0.01	±0.1	±0.5	μA
$\Delta I_{OFF}$	additional power-off leakage current	$      V_{I} \text{ or } V_{O} = 0 \text{ V or } 2.75 \text{ V};                                   $	[1]	-	0.02	±0.1	±0.5	μA
I <sub>CC</sub>	supply current	$V_I = 0 V \text{ or } V_{CC}; I_O = 0 A$	[1]	-	0.01	0.3	0.6	μA
$\Delta I_{CC}$	additional supply current			-	2	100	150	μA

[1] All typical values are measured at V<sub>CC</sub> = 1.2 V.

#### Low-power inverter with open-drain output

### **11. Dynamic characteristics**

#### Table 8. Dynamic characteristics

Voltages are referenced to GND (ground = 0 V); for test circuit, see <u>Figure 12</u>.

Symbol	Parameter	Conditions		T <sub>amb</sub> = 25 °C			T <sub>amb</sub> = -40 °C to +85 °C		Unit
				Min	Typ <mark>[1]</mark>	Max	Min	Max	
t <sub>pd</sub>	propagation	A to Y; see Figure 6	[2][3]						
	delay	$V_{CC}$ = 0.75 V to 0.85 V		3	12	33	3	104	ns
		$V_{CC}$ = 1.1 V to 1.3 V		2.2	5.1	7.9	2.0	8.3	ns
		$V_{CC}$ = 1.4 V to 1.6 V		1.7	3.7	5.2	1.5	5.6	ns
		$V_{CC}$ = 1.65 V to 1.95 V		1.4	3.5	5.3	1.2	5.6	ns
		$V_{CC}$ = 2.3 V to 2.7 V		1.2	2.6	3.8	1.0	4.0	ns
t <sub>t</sub>	transition time	$V_{CC} = 2.7 \text{ V}; \text{ see } \frac{\text{Figure 6}}{1000}$	[4]	-	-	-	0.9	-	ns
CI	input capacitance			-	0.5	-	-	-	pF
Co	output capacitance	$V_{O} = 0 V; V_{CC} = 0 V$		-	0.7	-	-	-	pF
C <sub>PD</sub>		$f_i = 1 \text{ MHz}; V_I = 0 \text{ V to } V_{CC}$	[5]						
	capacitance	$V_{CC}$ = 0.75 V to 0.85 V		-	0.9	-	-	-	pF
		$V_{CC}$ = 1.1 V to 1.3 V		-	1.0	-	-	-	pF
		$V_{CC}$ = 1.4 V to 1.6 V		-	1.0	-	-	-	pF
		$V_{CC}$ = 1.65 V to 1.95 V		-	1.1	-	-	-	pF
		$V_{CC}$ = 2.3 V to 2.7 V		-	1.3	-	-	-	pF

[1] All typical values are measured at nominal  $V_{\mbox{CC}}.$ 

 $\label{eq:tpd} [2] \quad t_{pd} \mbox{ is the same as } t_{PZL} \mbox{ and } t_{PLZ}.$ 

[3] For additional propagation delay (t<sub>PZL</sub>) values at different load capacitances see Figure 7 to Figure 11.

[4]  $t_t$  is the same as  $t_{TZL}$  and  $t_{TLZ}$ .

[5]  $C_{PD}$  is used to determine the dynamic power dissipation ( $P_D$  in  $\mu$ W).

 $P_D = C_{PD} \times V_{CC}^2 \times f_i + C_L \times V_{CC}^2 \times f_o$  where:

 $f_i$  = input frequency in MHz;

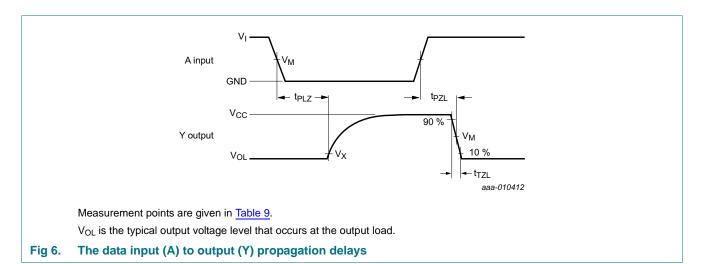
 $f_o = output frequency in MHz;$ 

 $C_L$  = output load capacitance in pF;

 $V_{CC}$  = supply voltage in V.

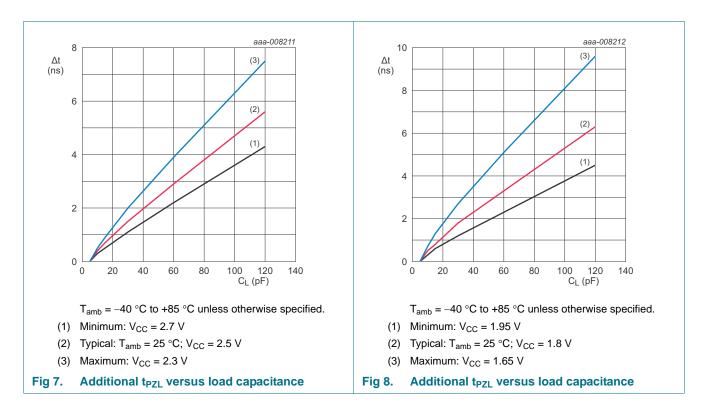
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### 12. Waveforms



#### Table 9.Measurement points

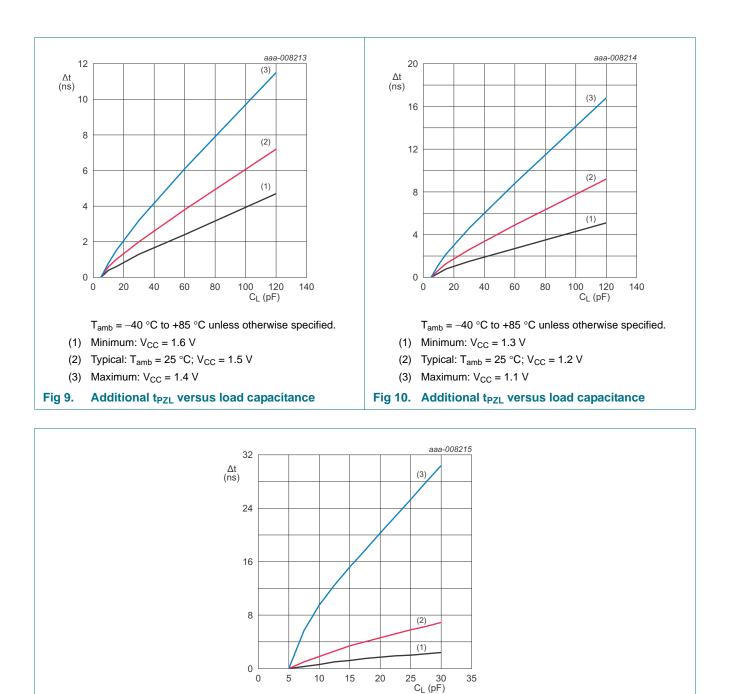
Supply voltage	Input			Output	
V <sub>CC</sub>	V <sub>M</sub>	VI	$t_r = t_f$	V <sub>M</sub>	V <sub>X</sub>
0.75 V to 1.6 V	0.5V <sub>CC</sub>	V <sub>CC</sub>	$\leq$ 3.0 ns	0.5V <sub>CC</sub>	$V_{OL} + 0.1 V$
1.65 V to 2.7 V	0.5V <sub>CC</sub>	V <sub>CC</sub>	$\leq 3.0 \text{ ns}$	0.5V <sub>CC</sub>	$V_{OL} + 0.15 V$



### **NXP Semiconductors**

# 74AXP1G06

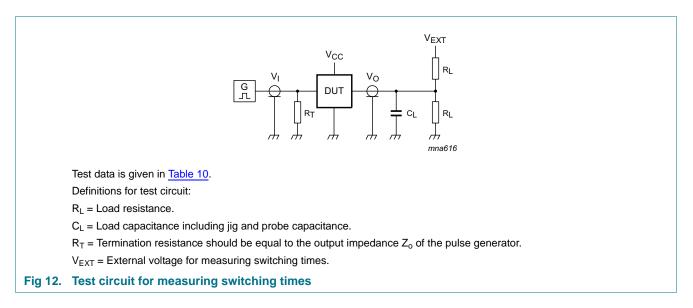
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 $T_{amb} = -40 \ ^{\circ}C$  to +85  $^{\circ}C$  unless otherwise specified.

- (1) Minimum:  $V_{CC} = 0.85 V$
- (2) Typical:  $T_{amb} = 25 \text{ °C}$ ;  $V_{CC} = 0.8 \text{ V}$
- (3) Maximum:  $V_{CC} = 0.75 V$
- Fig 11. Additional t<sub>PZL</sub> versus load capacitance

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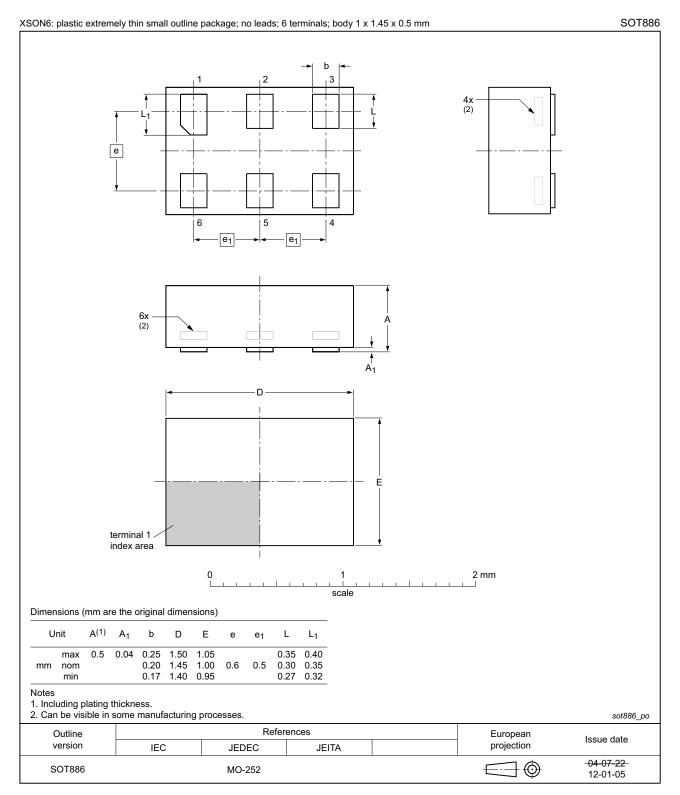


#### Table 10. Test data

Supply voltage	Load		V <sub>EXT</sub>	
V <sub>cc</sub>	CL	RL	t <sub>PLH</sub> , t <sub>PHL</sub>	t <sub>PZL</sub> , t <sub>PLZ</sub>
0.75 V to 2.7 V	5 pF	10 kΩ	0 V	$2 \times V_{CC}$

#### Low-power inverter with open-drain output

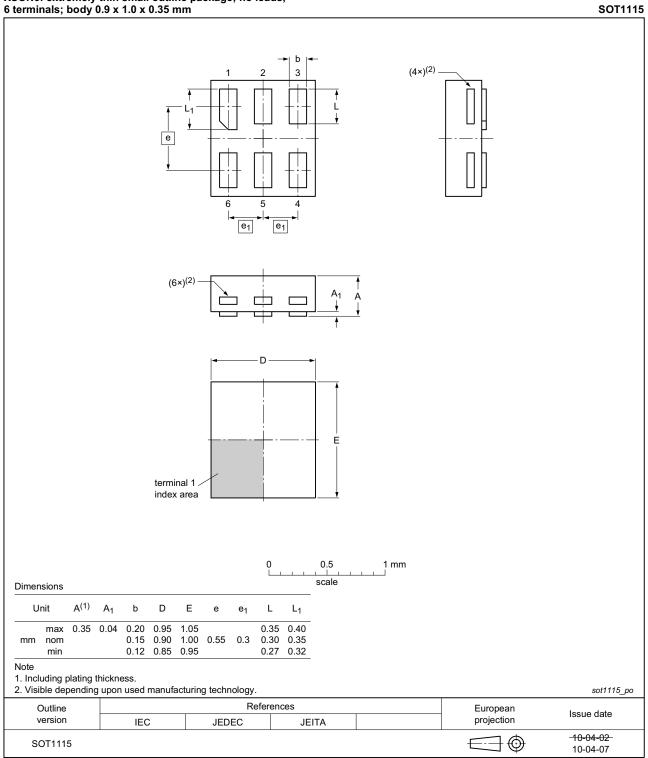
## 13. Package outline



#### Fig 13. Package outline SOT886 (XSON6)

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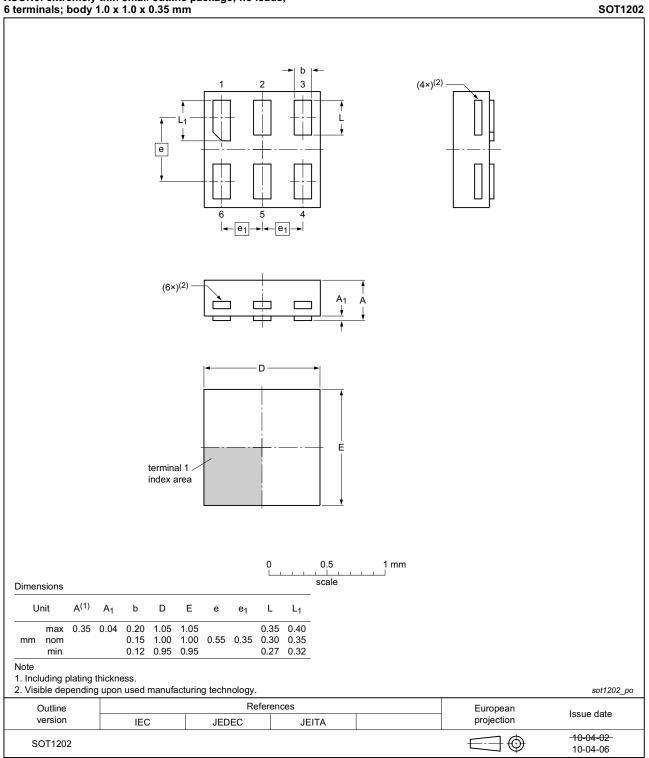


# XSON6: extremely thin small outline package; no leads; 6 terminals; body 0.9 x 1.0 x 0.35 mm

Fig 14. Package outline SOT1115 (XSON6)

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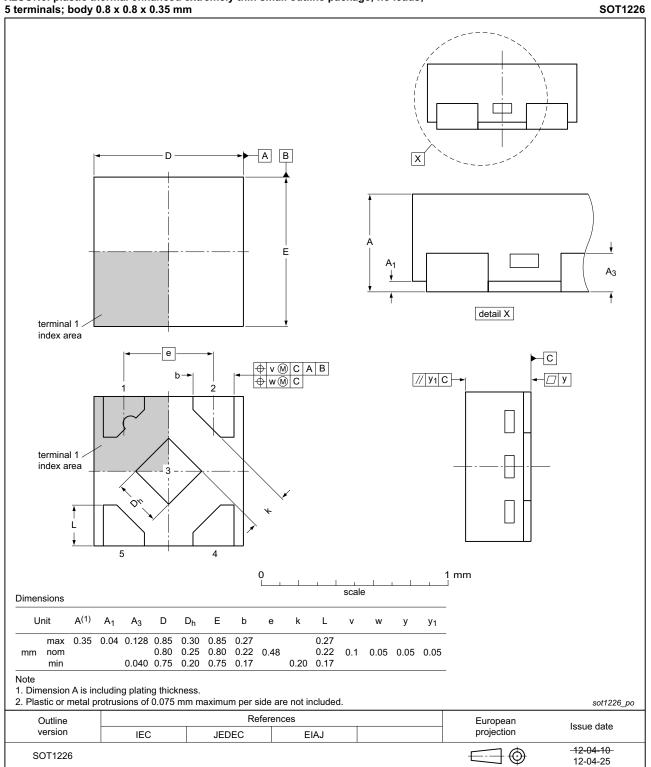


# XSON6: extremely thin small outline package; no leads; 6 terminals; body 1.0 x 1.0 x 0.35 mm

Fig 15. Package outline SOT1202 (XSON6)

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## X2SON5: plastic thermal enhanced extremely thin small outline package; no leads;

Fig 16. Package outline SOT1226 (X2SON5)

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## 14. Abbreviations

Table 11. Abbreviations				
Acronym	Description			
CDM	Charged Device Model			
DUT	Device Under Test			
ESD	ElectroStatic Discharge			
НВМ	Human Body Model			

## **15. Revision history**

Table 12. Revision history						
Document ID	Release date	Data sheet status	Change notice	Supersedes		
74AXP1G06 v.1	20140115	Product data sheet	-	-		

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Document status[1][2]	Product status <sup>[3]</sup>	Definition
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### **18. Contents**

1	General description 1
2	Features and benefits 1
3	Ordering information 2
4	Marking 2
5	Functional diagram 2
6	Pinning information 3
6.1	Pinning 3
6.2	Pin description 3
7	Functional description 3
8	Limiting values 4
9	Recommended operating conditions 4
10	Static characteristics 5
11	Dynamic characteristics 6
12	Waveforms 7
13	Package outline 10
14	Abbreviations 14
15	Revision history 14
16	Legal information
16.1	Data sheet status 15
16.2	Definitions 15
16.3	Disclaimers
16.4	Trademarks 16
17	Contact information 16
18	Contents 17

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